

## NCE N-Channel Enhancement Mode Power MOSFET

## **Description**

The NCE4555K uses advanced trench technology and design to provide excellent  $R_{\text{DS}(\text{ON})}$  with low gate charge. It can be used in a wide variety of applications.

### **General Features**

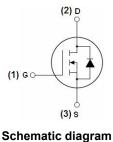
- V<sub>DS</sub> =45V,I<sub>D</sub> =55A
  - $R_{DS(ON)}$  = 9.2 m $\Omega$  @  $V_{GS}$  = 10 V (Typ)
  - $R_{DS(ON)} = 13m\Omega @ V_{GS} = 4.5V (Typ)$
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation

### **Application**

- Load switching
- Hard switched and high frequency circuits
- Uninterruptible power supply



100% AVds TESTED!





Marking and pin assignment



TO-252-2L top view

## **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE4555K	NCE4555K	TO-252-2L	-	-	-

# Absolute Maximum Ratings (T<sub>C</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	45	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I <sub>D</sub>	55	Α
Pulsed Drain Current	I <sub>DM</sub>	220	Α
Maximum Power Dissipation	P <sub>D</sub>	75	W
Derating factor		0.5	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	145	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 175	°C

### **Thermal Characteristic**

Thermal Resistance,Junction-to-Case <sup>(Note 2)</sup>	R <sub>0JC</sub>	2.0	°C/W
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# Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

Parameter	Symbol Condition		Min	Тур	Max	Unit	
Off Characteristics							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	45	-	-	V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =45V,V <sub>GS</sub> =0V	-	-	1	μA	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA	
On Characteristics (Note 3)				•			
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	1.2	1.6	2.5	V	
Drain Source On State Registance	В	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	9.2	11	m0	
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A	<sub>D</sub> =20A - 13		17	– mΩ	
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =10V,I <sub>D</sub> =20A	-	35	-	S	
Dynamic Characteristics (Note4)				•			
Input Capacitance	C <sub>lss</sub>	\/ 00\/\/ 0\/	-	1150	-	PF	
Output Capacitance	Coss	$V_{DS}$ =20V, $V_{GS}$ =0V, F=1.0MHz	-	135	-	PF	
Reverse Transfer Capacitance	Crss	F=1.0WHZ	-	125	-	PF	
Switching Characteristics (Note 4)				•			
Turn-on Delay Time	t <sub>d(on)</sub>		-	6	-	nS	
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =20V,R <sub>L</sub> =1 $\Omega$	-	17	-	nS	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{G}$ =3 $\Omega$	-	30	-	nS	
Turn-Off Fall Time	t <sub>f</sub>		-	17	-	nS	
Total Gate Charge	Qg	N/ 001/1 00A	-	32.5		nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =20V,I <sub>D</sub> =20A,	-	3.6		nC	
Gate-Drain Charge	Q <sub>gd</sub>	- V <sub>GS</sub> =10V	-	9.6		nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	55	Α	
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF = 20A	-	29	-	nS	
Reverse Recovery Charge	Qrr	di/dt = 100A/µs <sup>(Note3)</sup>		26	-	nC	
Forward Turn-On Time	ton	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				y LS+LD)	

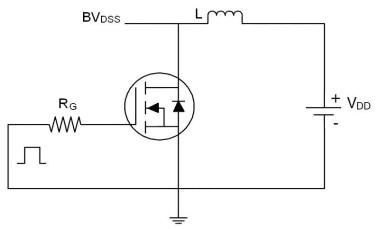
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec. The value of R<sub>θJA</sub> is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with T<sub>A</sub> =25°C. The Power dissipation PDSM is based on R<sub>θJA</sub> and the maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design, and the maximum temperature of 175°C may be used if the PCB allows it.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- **5.** E<sub>AS</sub> condition : Tj=25  $^{\circ}$ C,V<sub>DD</sub>=20V,V<sub>G</sub>=10V,L=0.5mH,Rg=25 $\Omega$ .

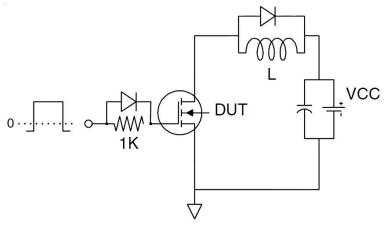


# **Test circuit**

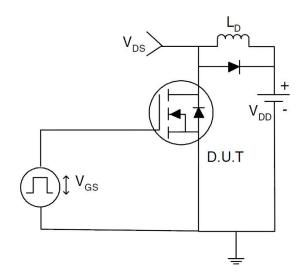
# 1) E<sub>AS</sub> Test Circuit



# 2) Gate Charge Test Circuit

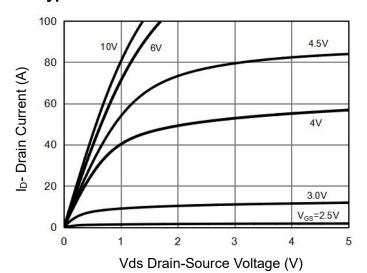


# 3) Switch Time Test Circuit

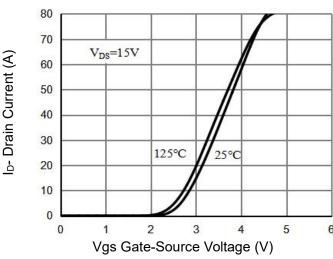




# **Typical Electrical and Thermal Characteristics (Curves)**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

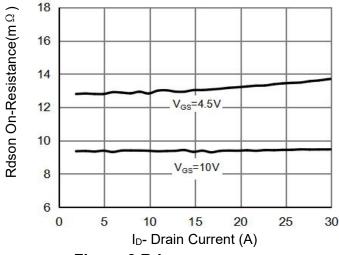


Figure 3 Rdson- Drain Current

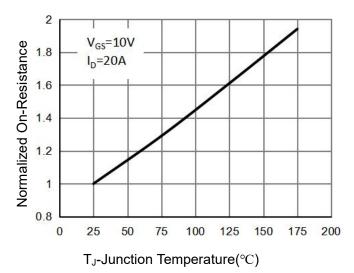
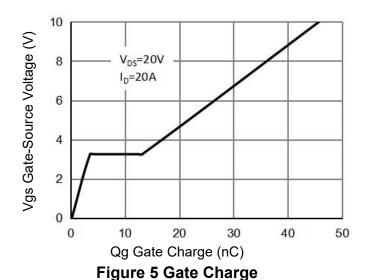


Figure 4 Rdson-JunctionTemperature



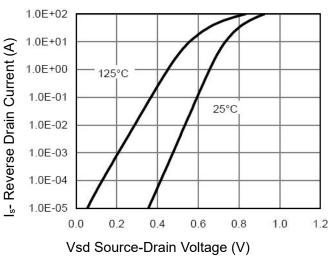


Figure 6 Source- Drain Diode Forward



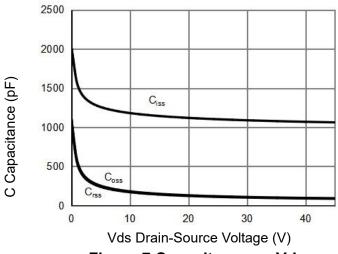


Figure 7 Capacitance vs Vds

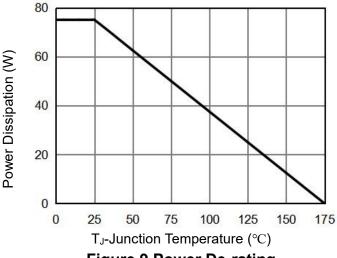
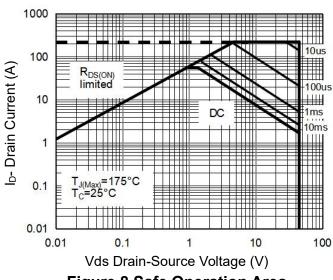


Figure 9 Power De-rating



**Figure 8 Safe Operation Area** 

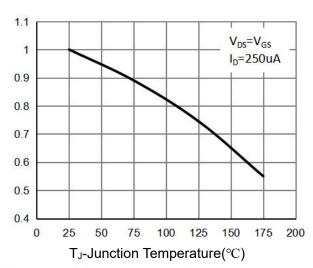


Figure 10 V<sub>GS(th)</sub> vs Junction Temperature

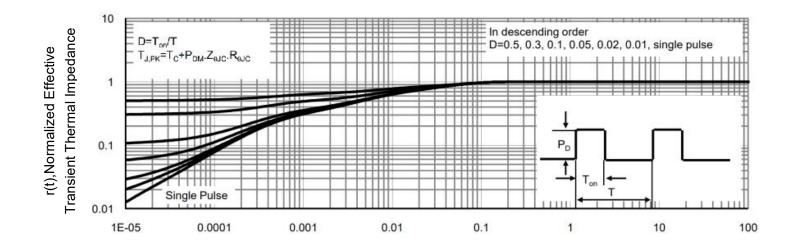
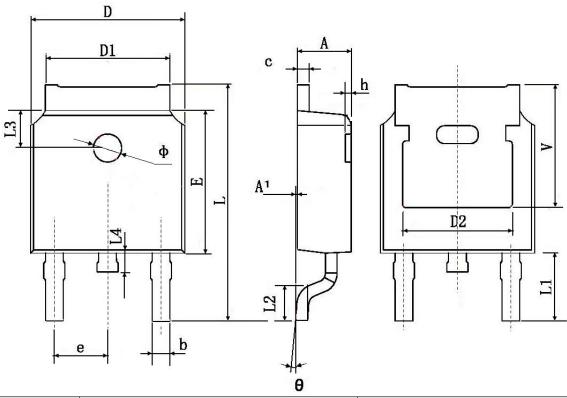


Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)



# **TO-252 Package Information**



Comple al	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830 TYP.		0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900	TYP.	0.114	0.114 TYP.	
L2	1.400	1.700	0.055	0.067	
L3	1.600	600 TYP. 0.063 TYP.		TYP.	
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211 TYP.		



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